August 2005

FDFM2N111 Integrated N-Channel PowerTrench<sup>®</sup> MOSFET and Schottky Diode

**FAIRCHILD** 

## FDFM2N111

# Integrated N-Channel PowerTrench® MOSFET and Schottky Diode

### **General Description**

FDFM2N111 combines the exceptional performance of Fairchild's PowerTrench MOSFET technology with a very low forward voltage drop Schottky barrier rectifier in a MicroFET package.

This device is designed specifically as a single package solution for Standard Buck Converter. It features a fast switching, low gate charge MOSFET with very low on-state resistance.

### Applications

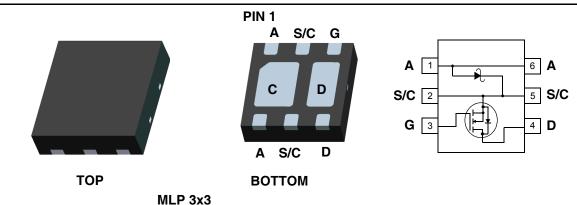
Standard Buck Converter

#### Features

■ 4 A, 20 V  $R_{DS(ON)} = 100m\Omega @ V_{GS} = 4.5 V$ 

 $R_{DS(ON)} = 150 m\Omega @ V_{GS} = 2.5 V$ 

Low Profile - 0.8 mm maximun - in the new package MicroFET 3x3 mm



## Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage		±12	V
1	Drain Current -Continuous (Note 1a)		4	
D	-Pulsed		10	— A
V <sub>RRM</sub>	Schottky Repetitive Peak Reverse voltage		20	V
lo	Schottky Average Forward Current (Note 1a)		2	Α
D	Power dissipation (Steady State)	(Note 1a)	1.7	w
P <sub>D</sub> Power dissipati	Power dissipation (Steady State)	(Note 1b)	0.8	~ ~
T <sub>J</sub> , T <sub>STG</sub>	I, T <sub>STG</sub> Operating and Storage Junction Temperature Range			°C

### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	70	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	150	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
2N111	FDFM2N111	7inch	12mm	3000 units

Symbol	Parameter	Test Co	onditions	Min	Тур	Max	Units
Off Chara	cteristics						
B <sub>VDSS</sub>	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$		20	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{,l}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , Referenced to 25°C		-	12	-	mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{D}$	<sub>S</sub> = 16V	-	-	1	μA
I <sub>GSS</sub>	Gate-Body Leakage,	V <sub>GS</sub> = ±12V, V	-	-	-	±100	nA
	cteristics (Note 2)						
V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D}$	a = 250μA	0.6	1.0	1.5	V
$\frac{\Delta V_{GS(TH)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$ , Referenced to		-	-3	-	mV/°C
41)				_	54	100	
<b>D</b>			$I_D = 4.0A, V_{GS} = 4.5V$ $I_D = 3.3A, V_{GS} = 2.5V$		83	150	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$I_D = 4.0A, V_{GS} = 4.5V,$ $T_J = 125^{\circ}C$		-	74	147	- mΩ
I <sub>D(ON)</sub>	On-State Drain Current	V <sub>GS</sub> = 2.5V, V	/ <sub>DS</sub> = 5V	10	-	-	Α
9 <sub>FS</sub>	Forward Transconductance	I <sub>D</sub> = 4A, V <sub>DS</sub> =	= 5V	-	9.7	-	S
Dvnamic	Characteristics						
C <sub>ISS</sub>	Input Capacitance			-	273	-	pF
C <sub>OSS</sub>	Output Capacitance	──V <sub>DS</sub> = 10V, V, f = 1MHz	$V_{DS} = 10V, V_{GS} = 0V,$		63	-	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			-	37	-	pF
R <sub>G</sub>	Gate Resistance	$V_{GS} = 0V, f =$	1MHz,	-	1.6	-	Ω
Switching	Given the provided and the provided of the provided and t						
t <sub>d(ON)</sub>	Turn-On Delay Time			-	6	12	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 10V, I_{D} = 1A$		-	7	14	ns
t <sub>d(OFF)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 4.5V, F	$V_{GS}$ = 4.5V, $R_{GEN}$ = 6 $\Omega$		11	20	ns
t <sub>f</sub>	Turn-Off Fall Time			-	1.7	3.4	ns
Qg	Total Gate Charge		V <sub>DS</sub> = 10V, I <sub>D</sub> = 4.0A,		2.7	3.8	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 4.5V$		-	0.6	-	nC
Q <sub>gd</sub>	Gate-Drain Charge			-	0.9	-	nC
Drain-Soι	urce Diode Characteristics and	l Maximum R	atings				
I <sub>S</sub>	Maximum Continuous Drain-Source Di			-	-	1.4	А
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_S =$	= 1.4 A (Note 2)	-	0.8	-1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time	L= 4.0A. dL-/0	dt=100A/us	-	11	-	ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	I <sub>F</sub> = 4.0A, dI <sub>F</sub> /dt=100A/μs		-	3	-	nC
Schottky	Diode Characteristic						
V <sub>R</sub>	Reverse Voltage	I <sub>R</sub> = 1mA		20	-	-	V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = 5V	T <sub>J</sub> = 25°C T <sub>J</sub> = 100°C	-	-	100 10	μA mA
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 1A	$T_{\rm J} = 100  \rm C$ $T_{\rm J} = 25^{\circ} \rm C$	-	0.32	0.39	V
1			0				

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# **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

### Notes:

1.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta CA}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



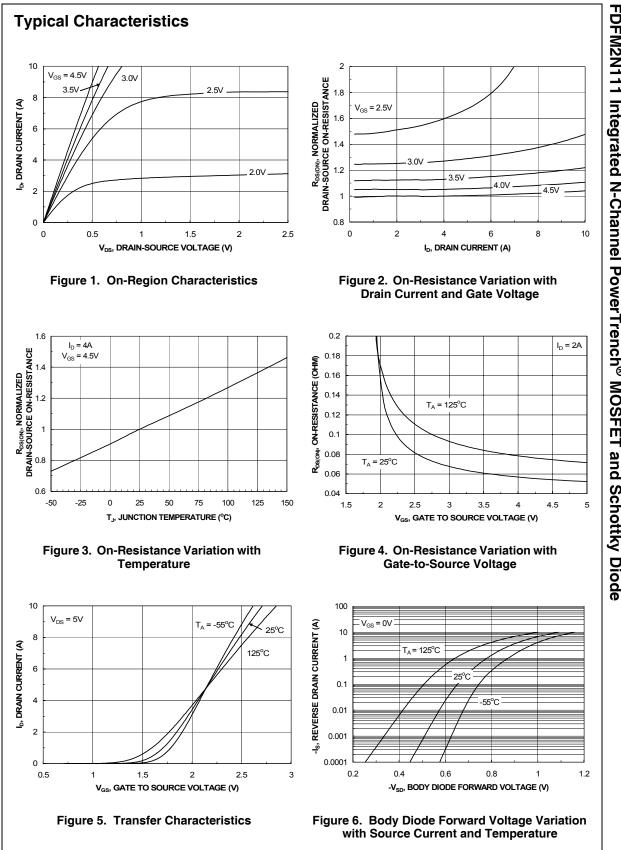
a) 70°C/W when mounted on a 1in<sup>2</sup> pad of 2 oz copper

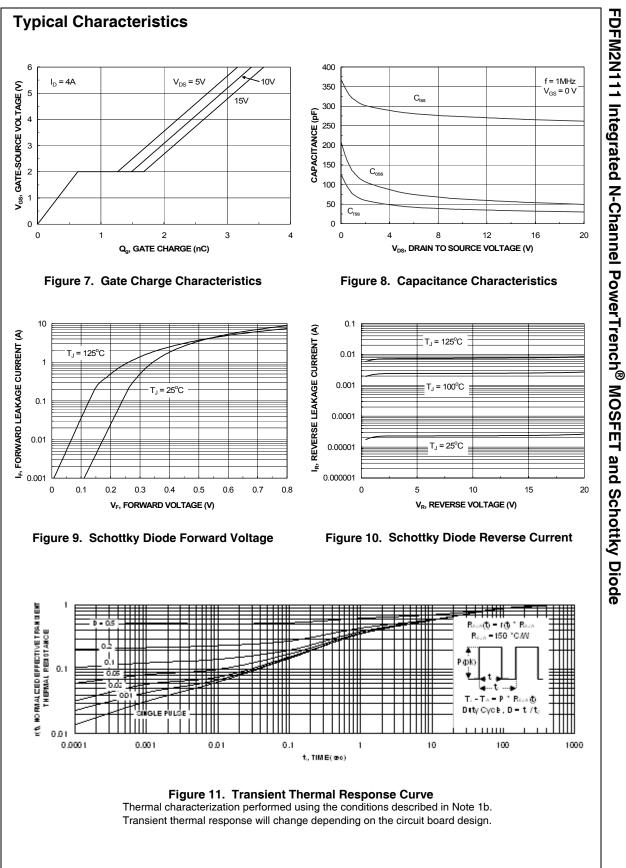
copper Scale 1: 1 o

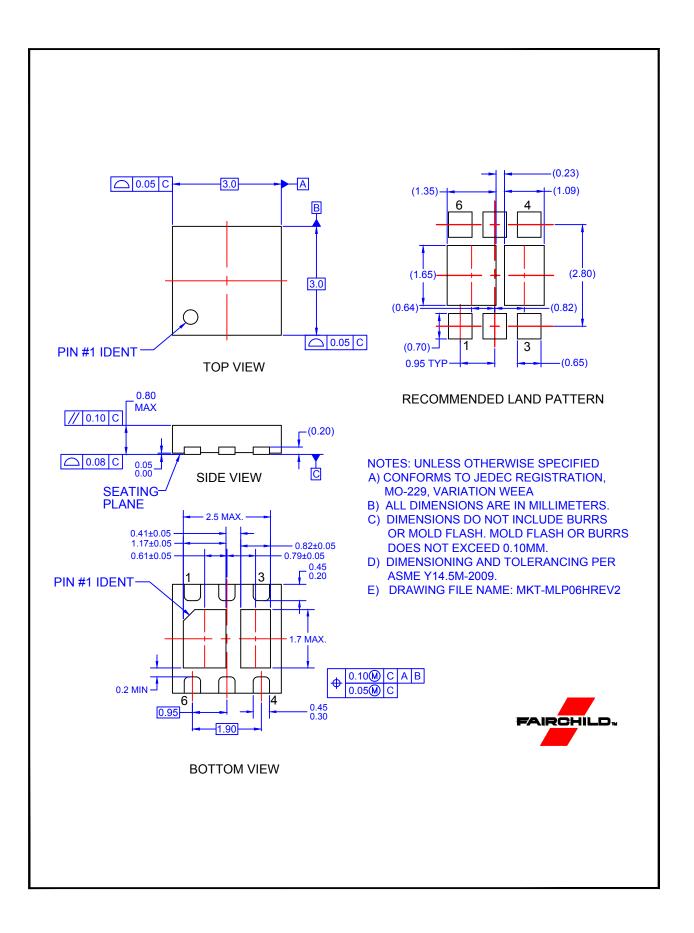
b) 150°C/W whe mounted on a minimum pad of 2 oz copper

Scale 1: 1 on letter size paper

**2.** Pulse Test: Pulse Width < 300  $\mu$ s, Duty Cycle < 2.0%









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